

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Tuomas Karkkainen</td> <td>05/01/2012</td> </tr> <tr> <td>Ossi Kalevo</td> <td>05/01/2012</td> </tr> </tbody> </table>		Name	Execution Date	Tuomas Karkkainen	05/01/2012	Ossi Kalevo	05/01/2012
Name	Execution Date						
Tuomas Karkkainen	05/01/2012						
Ossi Kalevo	05/01/2012						
RECEIVING PARTY DATA							
Name:	Gurulogic Microsystems, Inc.						
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City:	Turku						
State/Country:	FINLAND						
Postal Code:	20100						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13461029</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13461029		
Property Type	Number						
Application Number:	13461029						
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**ASSIGNMENT OF RIGHTS, TITLE AND INTEREST IN INVENTION**

*This is an assignment of the following rights, title and interest (check all that apply):*

- United States of America rights, title and interest in the invention*
- Foreign rights, title and interest in the invention*
- United States Patent Application Serial No. \_\_\_\_\_*  
*Date of Execution: \_\_\_\_\_ Date of Filing: \_\_\_\_\_*
- United States Provisional Patent Application Serial No. \_\_\_\_\_*
- United States Patent No(s). \_\_\_\_\_*
- International (PCT) Patent Application Serial No. \_\_\_\_\_*
- Other (specify) \_\_\_\_\_*

*Title of the Invention:*

PROCESSING OF IMAGE

*Inventor (assignor):*

<i>Name</i>	<i>Address</i>
Tuomas Kärkkäinen	Rautalankatu 2 B17 Turku 20230, Finland
Ossi Kalevo	Ketunhätä 1 Toijala 37800, Finland

*Assignee:*

<i>Name</i>	<i>Address</i>
Gurulogic Microsystems, Inc.	Linnankatu 34 Turku 20100 Finland

Whereas, I, the above-identified Inventor, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and /or patent(s) (hereinafter referred to as "Invention");

And, whereas I desire to assign my above-identified rights, title and interest in the Invention to the above-identified Assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

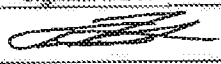
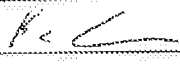
I hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said Invention, and in and to any and all reissues and reexaminations thereof, which may be granted or have granted for said Invention, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And I hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And I further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents; for filing divisions, continuations and continuation-in-part of said application for patent and/or for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

The undersigned hereby grant(s) the firm of LUCAS & MERCANTI, L.L.P., 475 Park Avenue South, New York, New York, 10016, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

*Inventor Signature:*

Name	Signature/ Date
Tuomas Kärkkäinen	 1st of MAY 2012
Ossi Kalevo	 1st of MAY 2012